Rochester Electronics

Datasheet

PART NUMBER

SN7495AJ-ROCV

Rochester Electronics Manufactured Components

Rochester branded components are manufactured using either die/wafers purchased from the original suppliers or Rochester wafers recreated from the original IP. All re-creations are done with the approval of the Original Component Manufacturer. (OCM)

Parts are tested using original factory test programs or Rochester developed test solutions to guarantee product meets or exceeds the OCM data sheet.

Quality Overview

- ISO-9001
- AS9120 certification
- Qualified Manufacturers List (QML) MIL-PRF-38535
    - Class Q Military
    - Class V Space Level

Qualified Suppliers List of Distributors (QSLD)

- Rochester is a critical supplier to DLA and meets all industry and DLA standards.

Rochester Electronics, LLC is committed to supplying products that satisfy customer expectations for quality and are equal to those originally supplied by industry manufacturers.

The original manufacturer's datasheet accompanying this document reflects the performance and specifications of the Rochester manufactured version of this device. Rochester Electronics guarantees the performance of its semiconductor products to the original OCM specifications. 'Typical' values are for reference purposes only. Certain minimum or maximum ratings may be based on product characterization, design, simulation, or sample testing.

TYPE	TYPICAL MAXIMUM CLOCK FREQUENCY	TYPICAL POWER DISSIPATION
'95A	36 MHz	195 mW
'LS95B	36 MHz	65 mW

description

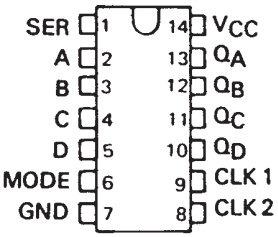
These 4-bit registers feature parallel and serial inputs, parallel outputs, mode control, and two clock inputs. The registers have three modes of operation:

Parallel (broadside) load
Shift right (the direction Q_A toward Q_D)
Shift left (the direction Q_D toward Q_A)

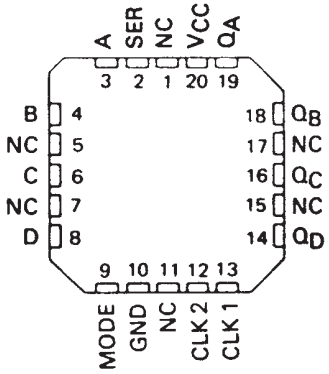
Parallel loading is accomplished by applying the four bits of data and taking the mode control input high. The data is loaded into the associated flip-flops and appears at the outputs after the high-to-low transition of the clock-2 input. During loading, the entry of serial data is inhibited.

Shift right is accomplished on the high-to-low transition of clock 1 when the mode control is low; shift left is accomplished on the high-to-low transition of clock 2 when the mode control is high by connecting the output of each flip-flop to the parallel input of the previous flip-flop (Q_D to input C, etc.) and serial data is entered at input D. The clock input may be applied commonly to clock 1 and clock 2 if both modes can be clocked from the same source. Changes at the mode control input should normally be made while both clock inputs are low; however, conditions described in the last three lines of the function table will also ensure that register contents are protected.

SN5495A, SN54LS95B . . . J OR W PACKAGE
SN7495A . . . N PACKAGE
SN74LS95B . . . D OR N PACKAGE
(TOP VIEW)



SN54LS95B . . . FK PACKAGE
(TOP VIEW)



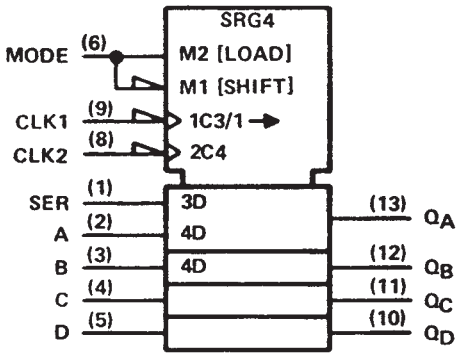
NC - No internal connection

FUNCTION TABLE

INPUTS								OUTPUTS			
MODE CONTROL	CLOCKS 2 (L)	CLOCKS 1 (R)	SERIAL	PARALLEL A	PARALLEL B	PARALLEL C	PARALLEL D	Q_A	Q_B	Q_C	Q_D
H	H	X	X	X	X	X	X	Q_{A0}	Q_{B0}	Q_{C0}	Q_{D0}
H	↓	X	X	a	b	c	d	a	b	c	d
H	↓	X	X	Q_B†	Q_C†	Q_D†	d	Q_{Bn}	Q_{Cn}	Q_{Dn}	d
L	L	H	X	X	X	X	X	Q_{A0}	Q_{B0}	Q_{C0}	Q_{D0}
L	X	↓	H	X	X	X	X	H	Q_{An}	Q_{Bn}	Q_{Cn}
L	X	↓	L	X	X	X	X	L	Q_{An}	Q_{Bn}	Q_{Cn}
↑	L	L	X	X	X	X	X	Q_{A0}	Q_{B0}	Q_{C0}	Q_{D0}
↓	L	L	X	X	X	X	X	Q_{A0}	Q_{B0}	Q_{C0}	Q_{D0}
↓	L	H	X	X	X	X	X	Q_{A0}	Q_{B0}	Q_{C0}	Q_{D0}
↑	H	L	X	X	X	X	X	Q_{A0}	Q_{B0}	Q_{C0}	Q_{D0}
↑	H	H	X	X	X	X	X	Q_{A0}	Q_{B0}	Q_{C0}	Q_{D0}

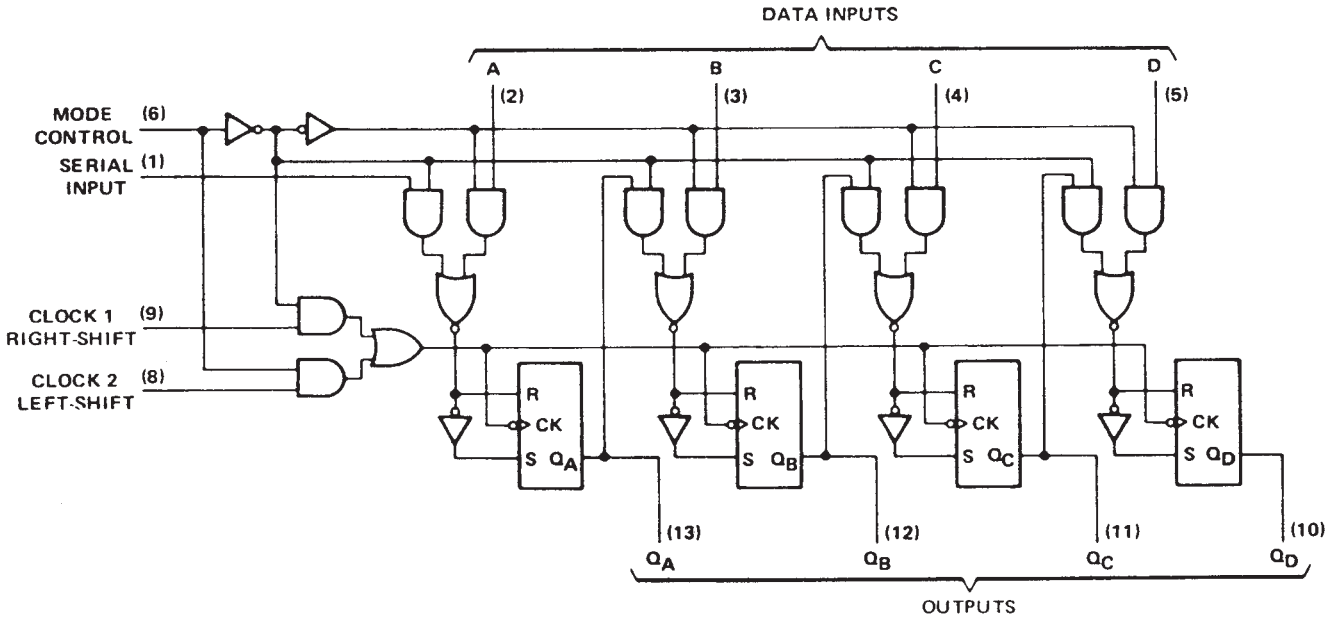
†Shifting left requires external connection of Q_B to A, Q_C to B, and Q_D to C. Serial data is entered at input D.
H = high level (steady state), L = low level (steady state), X = irrelevant (any input, including transitions)
↓ = transition from high to low level, ↑ = transition from low to high level
a, b, c, d = the level of steady-state input at inputs A, B, C, or D, respectively.
Q_{A0}, Q_{B0}, Q_{C0}, Q_{D0} = the level of Q_A, Q_B, Q_C, or Q_D, respectively, before the indicated steady-state input conditions were established.
Q_{An}, Q_{Bn}, Q_{Cn}, Q_{Dn} = the level of Q_A, Q_B, Q_C, or Q_D, respectively, before the most-recent ↓ transition of the clock.

logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for D, J, N, and W packages.

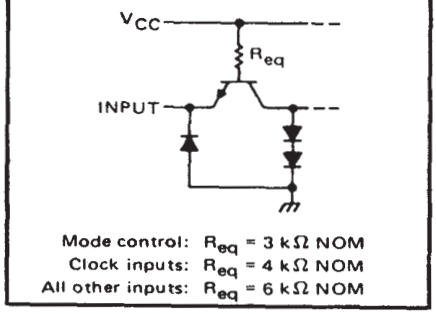
logic diagram (positive logic)



schematics of inputs and outputs

'95A

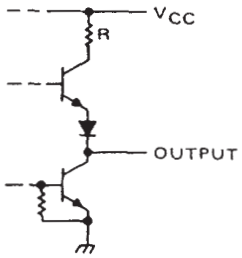
EQUIVALENT OF EACH INPUT



Mode control: R_{eq} = 3 kΩ NOM
Clock inputs: R_{eq} = 4 kΩ NOM
All other inputs: R_{eq} = 6 kΩ NOM

'95A

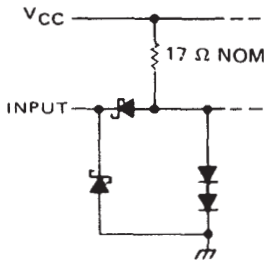
TYPICAL OF ALL OUTPUTS



'95A: R = 100 Ω
'L95: R = 500 Ω

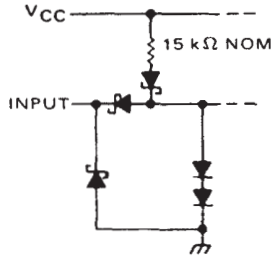
'LS95B

EQUIVALENT OF CLOCK AND MODE CONTROL INPUTS



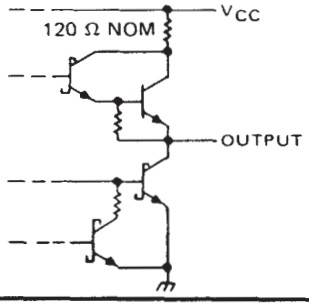
'LS95B

EQUIVALENT OF DATA AND SERIAL INPUTS



'LS95B

TYPICAL OF ALL OUTPUTS



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

	SN54′	SN54LS′	SN74′	SN74LS′	UNIT
Supply voltage, V_{CC} (see Note 1)	7	7	7	7	V
Input voltage	5.5	7	5.5	7	V
Interemitter voltage (see Note 2)	5.5		5.5		V
Operating free-air temperature range	−55 to 125		0 to 70		°C
Storge temperature range	−65 to 150		−65 to 150		°C

NOTES: 1. Voltage values, except interemitter voltage, are with respect to network ground terminal.
2. This is the voltage between two emitters of a multiple-emitter input transistor. This rating applies between the clock-2 input and the mode control input of the '95A.

recommended operating conditions

	SN5495A			SN7495A			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}	4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}			−800			−800	μA
Low-level output current, I_{OL}			16			16	mA
Clock frequency, f_{clock}	0		25	0		25	MHz
Width of clock pulse, $t_{w(clock)}$ (See Figure 1)	20			20			ns
Setup time, high-level or low-level data, t_{su} (See Figure 1)	15			15			ns
Hold time, high-level or low-level data, t_h (See Figure 1)	0			0			ns
Time to enable clock 1, $t_{enable\ 1}$ (See Figure 2)	15			15			ns
Time to enable clock 2 (See Figure 2)	15			15			ns
Time to inhibit clock 1, $t_{inhibit\ 1}$ (See Figure 2)	5			5			ns
Time to inhibit clock 2, $t_{inhibit\ 2}$ (See Figure 2)	5			5			ns
Operating free-air temperature, T_A	−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS†	SN5495A			SN7495A			UNIT
				MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IH}	High-level input voltage			2			2			V
V_{IL}	Low-level input voltage					0.8			0.8	V
V_{IK}	Input clamp voltage		V_{CC} = MIN, I_I = −12 mA			−1.5			−1.5	V
V_{OH}	High-level output voltage		V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OH} = −800 μA	2.4	3.4		2.4	3.4		V
V_{OL}	Low-level output voltage		V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OL} = 16 mA		0.2	0.4		0.2	0.4	V
I_I	Input current at maximum input voltage		V_{CC} = MAX, V_I = 5.5 V			1			1	mA
I_{IH}	High-level input current	Serial, A, B, C, D, Clock 1 or 2	V_{CC} = MAX, V_I = 2.4 V			40			40	μA
		Mode control				80			80	
I_{IL}	Low-level input current	Serial, A, B, C, D, Clock 1 or 2	V_{CC} = MAX, V_I = 0.4 V			−1.6			−1.6	mA
		Mode control				−3.2			−3.2	
I_{OS}	Short-circuit output current§		V_{CC} = MAX	−18		−57	−18		−57	mA
I_{CC}	Supply current		V_{CC} = MAX, See Note 3		39	63		39	63	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time.
NOTE 3: I_{CC} is measured with all outputs and serial input open; A, B, C, and D inputs grounded; mode control at 4.5 V; and a momentary 3 V, then ground, applied to both clock inputs.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
f_{max}	Maximum clock frequency	C_L = 15 pF, R_L = 400 Ω, See Figure 1	25	36		MHz
t_{PLH}	Propagation delay time, low-to-high-level output from clock			18	27	ns
t_{PHL}	Propagation delay time, high-to-low-level output from clock			21	32	ns

recommended operating conditions

	SN54LS95B			SN74LS95B			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}	4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}			−400			−400	μA
Low-level output current, I_{OL}			4			8	mA
Clock frequency, f_{clock}	0		25	0		25	MHz
Width of clock pulse, $t_{w(clock)}$ (see Figure 1)	20			20			ns
Setup time, high-level or low-level data, t_{su} (see Figure 1)	20			20			ns
Hold time, high-level or low-level data, t_h (see Figure 1)	20			10			ns
Time to enable clock 1, $t_{enable\ 1}$ (see Figure 2)	20			20			ns
Time to enable clock 2, $t_{enable\ 2}$ (see Figure 2)	20			20			ns
Time to inhibit clock 1, $t_{inhibit\ 1}$ (see Figure 2)	20			20			ns
Time to inhibit clock 2, $t_{inhibit\ 2}$ (see Figure 2)	20			20			ns
Operating free-air temperature, T_A	−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

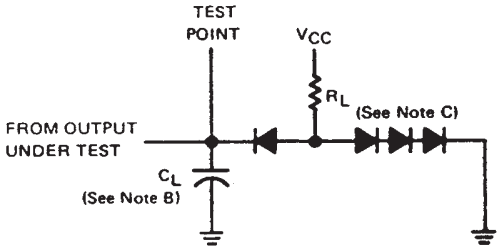
PARAMETER		TEST CONDITIONS†		SN54LS95B			SN74LS95B			UNIT
				MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IH}	High-level input voltage			2			2			V
V_{IL}	Low-level input voltage					0.7			0.8	V
V_{IK}	Input clamp voltage	V_{CC} = MIN,	I_I = −18 mA			−1.5			−1.5	V
V_{OH}	High-level output voltage	V_{CC} = MIN, V_{IL} = V_{IL} max,	V_{IH} = 2 V, I_{OH} = −400 μA	2.5	3.4		2.7	3.4		V
V_{OL}	Low-level output voltage	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = V_{IL} max	I_{OL} = 4 mA		0.25	0.4		0.25	0.4	V
			I_{OL} = 8 mA					0.35	0.5	
I_I	Input current at maximum input voltage	V_{CC} = MAX,	V_I = 7 V			0.1			0.1	mA
I_{IH}	High-level input current	V_{CC} = MAX,	V_I = 2.7 V			20			20	μA
I_{IL}	Low-level input current	V_{CC} = MAX,	V_I = 0.4 V			−0.4			−0.4	mA
I_{OS}	Short-circuit output current§	V_{CC} = MAX		−20		−100	−20		−100	mA
I_{CC}	Supply current	V_{CC} = MAX,	See Note 3		13	21		13	21	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.
NOTE 3: I_{CC} is measured with all outputs and serial input open; A, B, C, and D inputs grounded; mode control at 4.5 V; and a momentary 3 V, then ground, applied to both clock inputs.

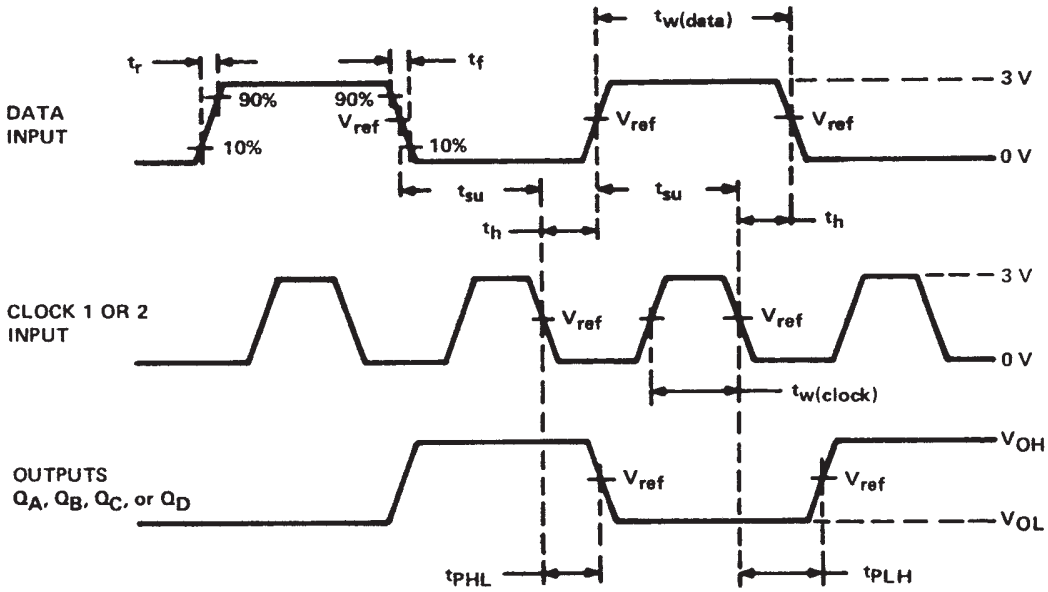
switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
f_{max}	Maximum clock frequency	C_L = 15 pF, R_L = 2 kΩ, See Figure 1	25	36		MHz
t_{PLH}	Propagation delay time, low-to-high-level output from clock			18	27	ns
t_{PHL}	Propagation delay time, high-to-low-level output from clock			21	32	ns

PARAMETER MEASUREMENT INFORMATION



LOAD CIRCUIT



NOTES: A. Input pulses are supplied by a generator having the following characteristics: $t_r \leq 10$ ns, $t_f \leq 10$ ns, and $Z_{out} \approx 50\ \Omega$. For the data pulse generator, PRR = 500 kHz; for the clock pulse generator, PRR = 1 MHz. When testing f_{max}, vary PRR. For '95A, $t_{w(data)} \geq 20$ns, $t_{w(clock)} \geq 15$ ns. For 'LS95B, $t_{w(data)} \geq 20$ ns, $t_{w(clock)} \geq 15$ ns.

B. C_L includes probe and jig capacitance.

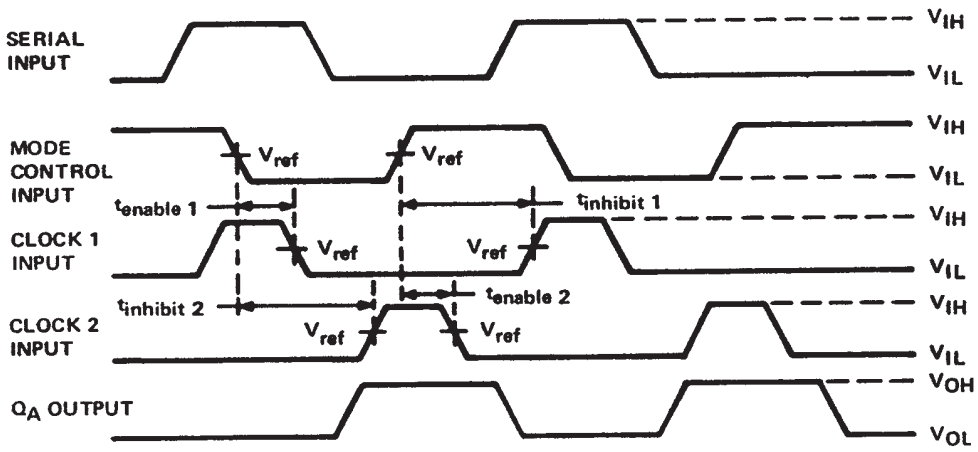
C. All diodes are 1N3064 equivalent.

D. For '95A, $V_{ref} = 1.5$ V; for 'LS95B, $V_{ref} = 1.3$ V.

VOLTAGE WAVEFORMS

FIGURE 1-SWITCHING TIMES

PARAMETER MEASUREMENT INFORMATION



NOTES: A. Input is at a low level.
B. For '95A, V_{ref} = 1.5 V; for 'LS958, V_{ref} = 1.3 V.

VOLTAGE WAVEFORMS

FIGURE 2-CLOCK ENABLE/INHIBIT TIMES

PACKAGING INFORMATION

Orderable Device	Status [1]	Package Type	Package Drawing	Pins	Package Qty	Eco Plan [2]	Lead/Ball Finish	MSL Peak Temp [3]
SN5495AJ	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SN7495AJ	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SN7495AJ	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SN7495AN	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN7495AN	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN74LS95BD	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI
SN74LS95BD	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI
SN74LS95BDR	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI
SN74LS95BDR	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI
SN74LS95BN	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN74LS95BN	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SNJ5495AJ	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SNJ5495AJ	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SNJ5495AW	OBSOLETE	CFP	W	14		TBD	Call TI	Call TI
SNJ5495AW	OBSOLETE	CFP	W	14		TBD	Call TI	Call TI

[1] The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

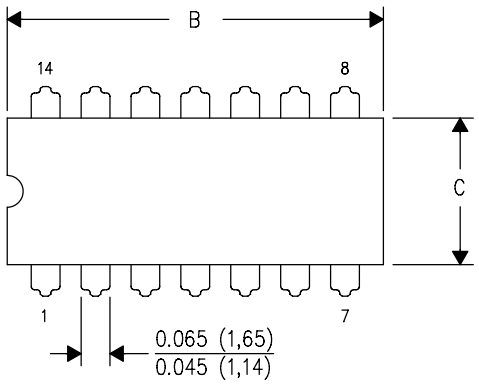
[2] Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

[3] MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

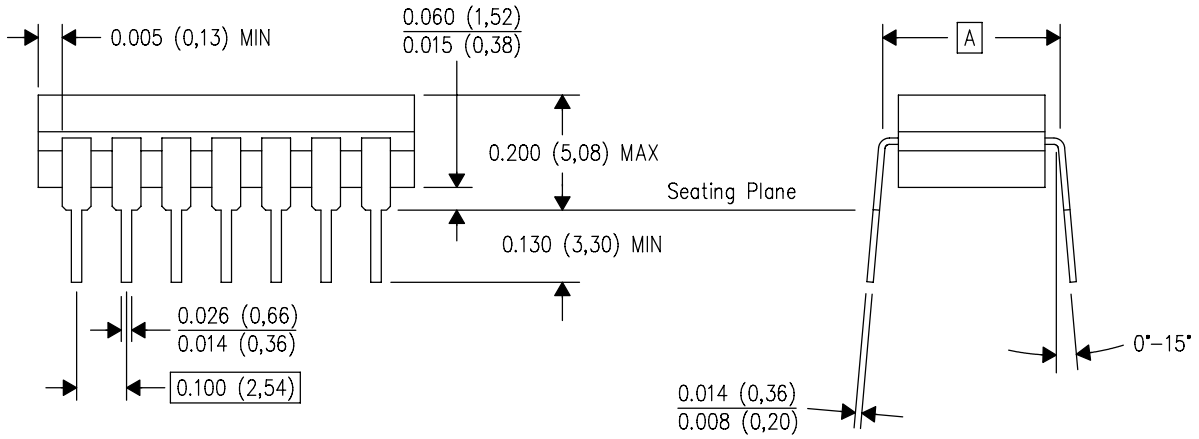
J (R–GDIP–T**)

14 LEADS SHOWN

CERAMIC DUAL IN–LINE PACKAGE



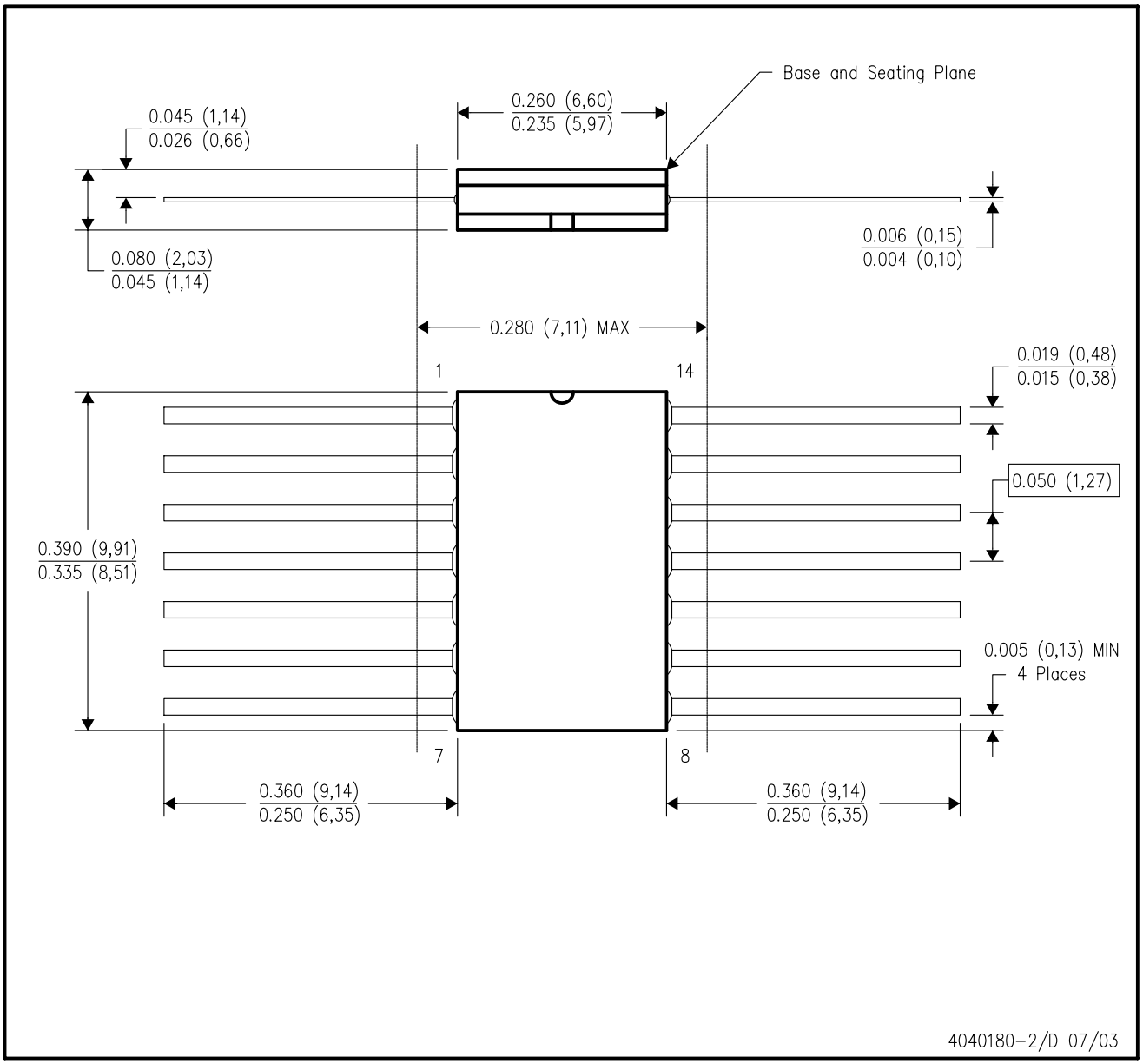
DIM \ PINS **	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



4040083/F 03/03

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package is hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
E. Falls within MIL STD 1835 GDIP1–T14, GDIP1–T16, GDIP1–T18 and GDIP1–T20.

W (R–GDFP–F14) CERAMIC DUAL FLATPACK

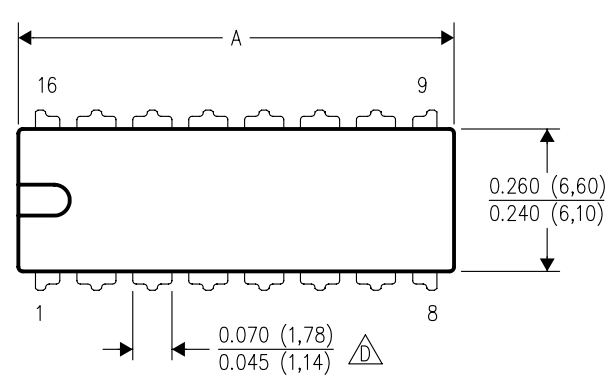


NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only.
E. Falls within MIL STD 1835 GDFP1–F14 and JEDEC MO–092AB

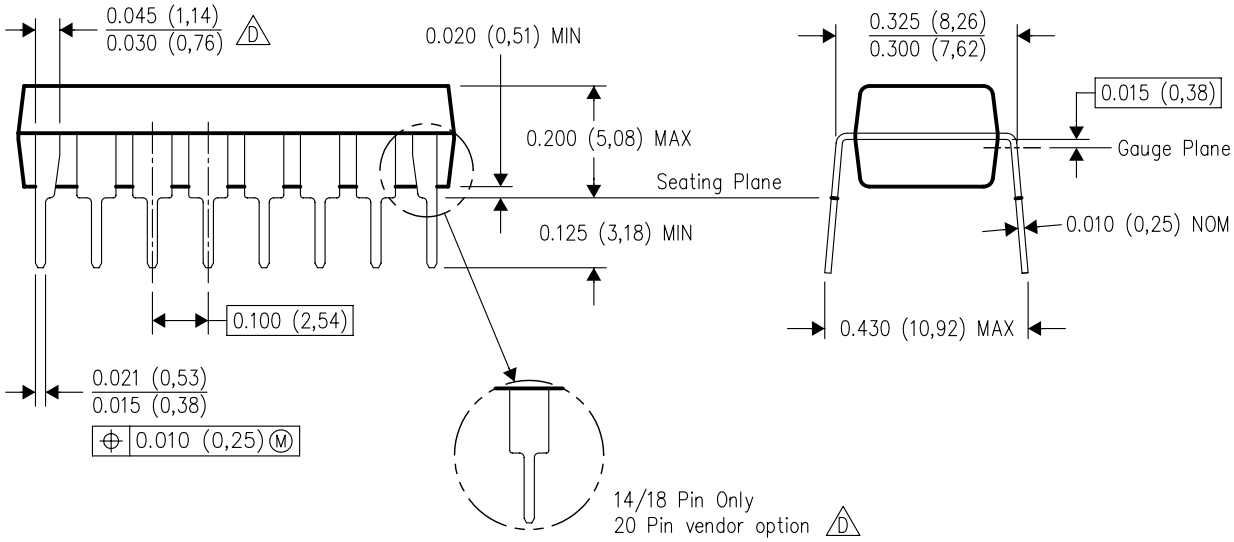
N (R–PDIP–T**)

PLASTIC DUAL–IN–LINE PACKAGE

16 PINS SHOWN



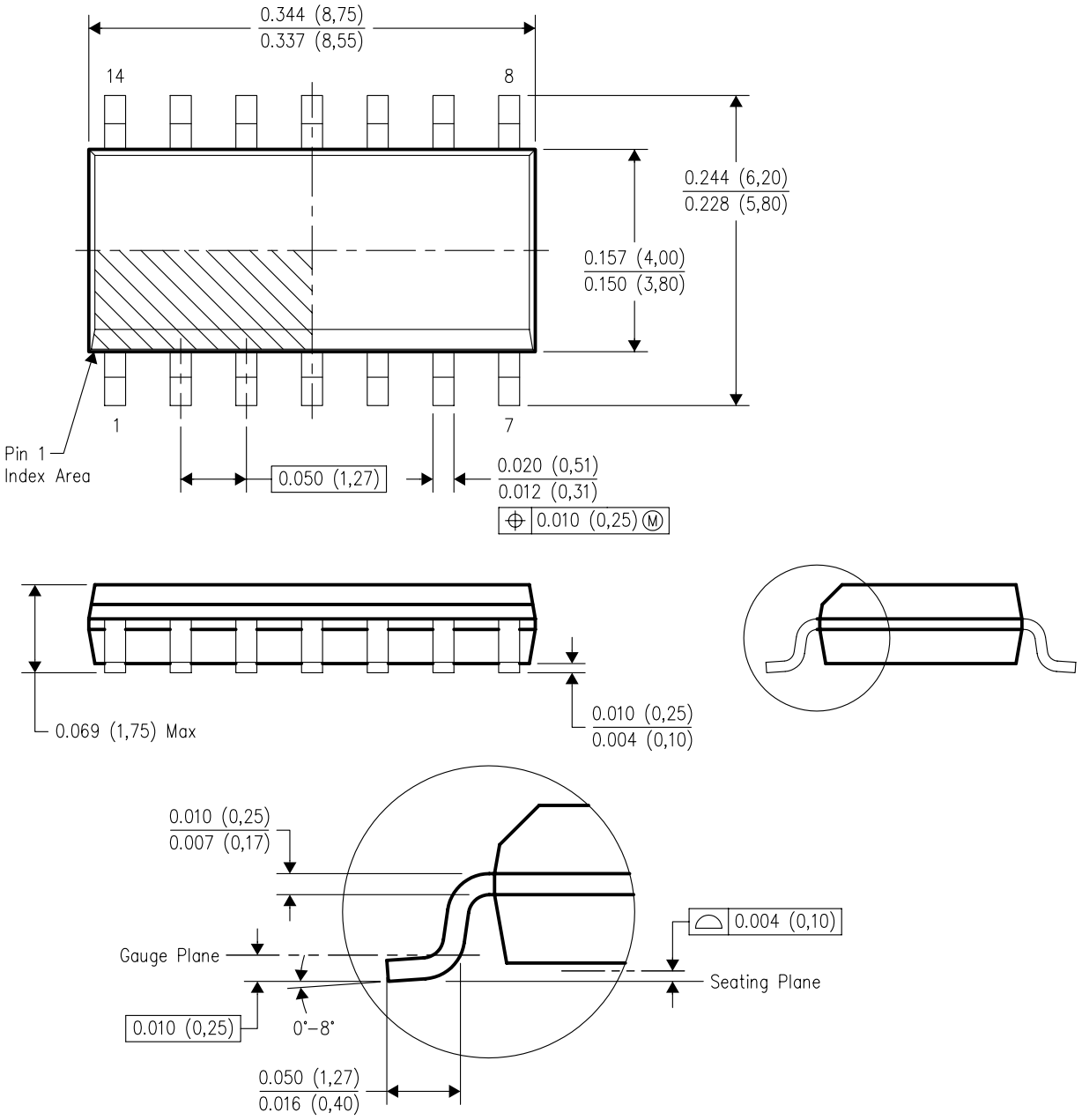
DIM \ PINS **	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS–001 VARIATION (C)	AA	BB	AC	AD



4040049/E 12/2002

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS–001, except 18 and 20 pin minimum body length (Dim A).
D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

D (R–PDSO–G14) PLASTIC SMALL–OUTLINE PACKAGE



NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
D. Falls within JEDEC MS–012 variation AB.

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		**Applications**	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
		Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments
Post Office Box 655303 Dallas, Texas 75265